

WSP4410

N-Ch MOSFET

#### **General Description**

The WSP4410 is the highest performance trench N-Ch MOSFET with extreme high cell density, which provide excellent RDSON and gate charge for most of the synchronous buck converter applications.

The WSP4410 meet the RoHS and Green Product requirement, 100% EAS guaranteed with full function reliability approved.

#### **Features**

- Advanced high cell density Trench technology
- Super Low Gate Charge
- Excellent CdV/dt effect decline
- 100% EAS Guaranteed
- Green Device Available

#### **Product Summery**

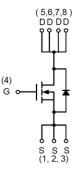
BVDSS	RDSON	ID
30V	$4m\Omega$	20A

#### Applications

- High Frequency Point-of-Load Synchronous Buck Converter for MB/NB/UMPC/VGA
- Networking DC-DC Power System
- Load Switch

#### **SOP-8** Pin Configuration





#### **Absolute Maximum Ratings** Symbol Parameter Rating Units Drain-Source Voltage 30 V $V_{DS}$ Gate-Source Voltage v $V_{GS}$ $\pm 20$ 20 Continuous Drain Current, V<sub>GS</sub> @ 10V<sup>1</sup> I<sub>D</sub>@T<sub>c</sub>=25℃ А Continuous Drain Current, V<sub>GS</sub> @ 10V<sup>1</sup> 15.8 I<sub>D</sub>@T<sub>c</sub>=70℃ А Pulsed Drain Current<sup>2</sup> 80 А $I_{DM}$ EAS Single Pulse Avalanche Energy<sup>3</sup> 31 mJ Avalanche Current 25 А $I_{AS}$ P<sub>D</sub>@T<sub>A</sub>=25℃ W Total Power Dissipation<sup>4</sup> 4.2 Storage Temperature Range -55 to 150 T<sub>STG</sub> °C $T_{\rm J}$ **Operating Junction Temperature Range** -55 to 150 °C

#### Thermal Data

Symbol	Parameter	Тур.	Max.	Unit	
R <sub>eja</sub>	Thermal Resistance Junction-ambient <sup>1</sup>		65	°C/W	
R <sub>θJC</sub>	Thermal Resistance Junction-Case <sup>1</sup>		25	°C/W	



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#### Electrical Characteristics (T<sub>J</sub>=25 °C, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V , I <sub>D</sub> =250uA	30			V
$\triangle BV_{DSS} / \triangle T_J$	BVDSS Temperature Coefficient	Reference to 25 $^\circ\!\!{\rm C}$ , I_D=1mA		0.028		V/℃
R <sub>DS(ON)</sub>	Static Drain-Source On-Resistance <sup>2</sup>	V <sub>GS</sub> =10V , I <sub>D</sub> =20A		4.0	5.5	mΩ
		V <sub>GS</sub> =4.5V , I <sub>D</sub> =14A		6.0	6.8	
V <sub>GS(th)</sub>	Gate Threshold Voltage		1.3	1.8	2.5	V
$ riangle V_{GS(th)}$	V <sub>GS(th)</sub> Temperature Coefficient	$V_{GS}=V_{DS}$ , $I_{D}=250$ uA		-6.16		mV/℃
	Drain-Source Leakage Current	V <sub>DS</sub> =24V , V <sub>GS</sub> =0V , T <sub>J</sub> =25°C			1	
I <sub>DSS</sub>		V <sub>DS</sub> =24V , V <sub>GS</sub> =0V , T <sub>J</sub> =55℃			5	uA
I <sub>GSS</sub>	Gate-Source Leakage Current	$V_{GS}=\pm20V$ , $V_{DS}=0V$			±100	nA
gfs	Forward Transconductance	V <sub>DS</sub> =5V , I <sub>D</sub> =12A		18		S
Rg	Gate Resistance	V <sub>DS</sub> =0V , V <sub>GS</sub> =0V , f=1MHz		2.4		Ω
Qg	Total Gate Charge (4.5V)	V <sub>DS</sub> =15V , V <sub>GS</sub> =4.5V , I <sub>D</sub> =20A		12.9		
Q <sub>gs</sub>	Gate-Source Charge			4.22		nC
Q <sub>gd</sub>	Gate-Drain Charge			7.3		
T <sub>d(on)</sub>	Turn-On Delay Time			14	26	
Tr	Rise Time	$V_{DD}$ =15V , $V_{GS}$ =10V , $R_{G}$ =6 $\Omega$		10	19	ns
T <sub>d(off)</sub>	Turn-Off Delay Time	I <sub>D</sub> =10A, R∟=15Ω		44	80	
T <sub>f</sub>	Fall Time			12	23	
Ciss	Input Capacitance	V <sub>DS</sub> =15V , V <sub>GS</sub> =0V , f=1MHz		1700		
C <sub>oss</sub>	Output Capacitance			265		pF
C <sub>rss</sub>	Reverse Transfer Capacitance			165		1

#### **Guaranteed Avalanche Characteristics**

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
EAS	Single Pulse Avalanche Energy $^5$	V <sub>DD</sub> =25V , L=0.1mH , I <sub>AS</sub> =25A	28			mJ

### **Diode Characteristics**

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Is	Continuous Source Current <sup>1,6</sup>				20	А
I <sub>SM</sub>	Pulsed Source Current <sup>2,6</sup>	$V_G = V_D = 0V$ , Force Current			80	А
V <sub>SD</sub>	Diode Forward Voltage <sup>2</sup>	V <sub>GS</sub> =0V , I <sub>S</sub> =5A , T <sub>J</sub> =25℃			1.1	V
trr	Reverse Recovery Time			10		nS
Qrr	Reverse Recovery Charge	IF=20A , dI/dt=100A/ $\mu s$ , T $_{ m J}$ =25 $^\circ \!\!\! { m C}$		3		nC

Note :

1. The data tested by surface mounted on a 1 inch<sup>2</sup> FR-4 board with 2OZ copper,t<10sec.

2.The data tested by pulsed , pulse width  $\,\leq\,$  300us , duty cycle  $\,\leq\,$  2%

3. The EAS data shows Max. rating . The test condition is  $V_{DD}$ =25V, $V_{GS}$ =10V,L=0.1mH,I<sub>AS</sub>=25A

4. The power dissipation is limited by 150 °C junction temperature

5. The Min. value is 100% EAS tested guarantee.

6. The data is theoretically the same as  $I_{\text{D}}$  and  $I_{\text{DM}}$  , in real applications , should be limited by total power dissipation.



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#### **Typical Characteristics**

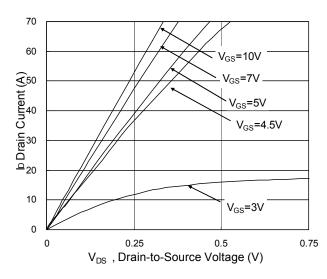


Fig.1 Typical Output Characteristics

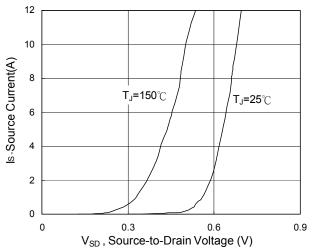


Fig.3 Forward Characteristics of Reverse

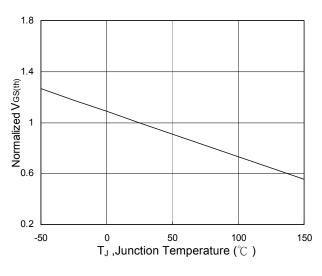


Fig.5 Normalized  $V_{GS(th)}$  vs.  $T_J$ 

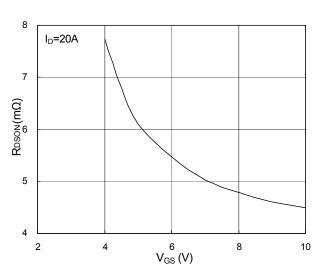


Fig.2 On-Resistance vs. Gate-Source

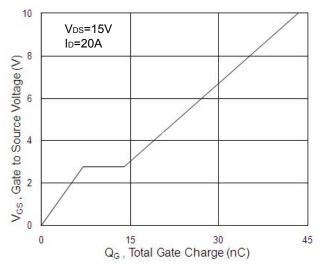


Fig.4 Gate-Charge Characteristics

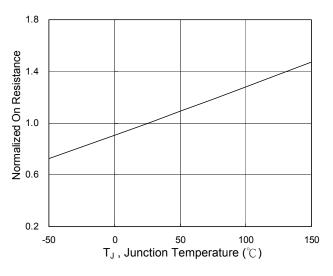


Fig.6 Normalized  $R_{DSON}$  vs.  $T_J$ 

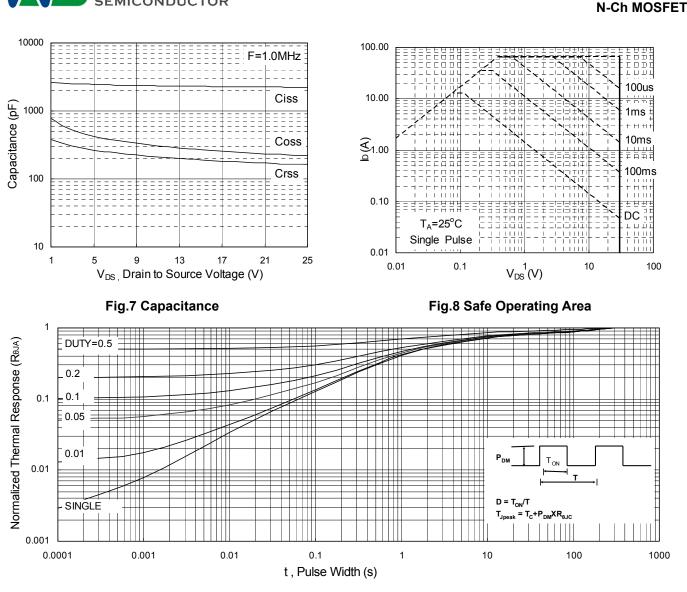
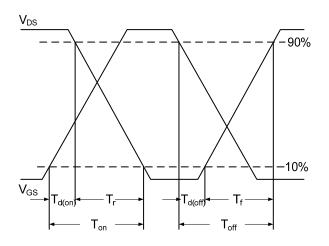
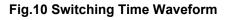


Fig.9 Normalized Maximum Transient Thermal Impedance



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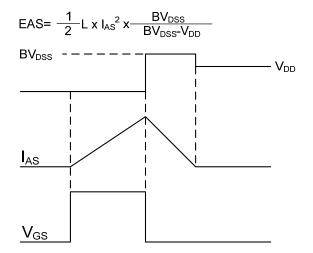


Fig.11 Unclamped Inductive Switching Waveform

**WSP4410** 



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